

Phase Control Thyristors (Hockey PUK Version), 650 A



E-PUK (TO-200AB)

PRIMARY CHARACTERISTICS					
I _{T(AV)}	650 A				
V _{DRM} /V _{RRM}	400 V, 800 V, 1200 V, 1600 V, 1800 V, 2000 V				
V_{TM}	2.18 V				
I _{GT}	100 mA				
T_J	-40 °C to +125 °C				
Package	E-PUK (TO-200AB)				
Circuit configuration	Single SCR				

FEATURES

- · Center amplifying gate
- Metal case with ceramic insulator
- International standard case E-PUK (TO-200AB)



- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
		650	A			
I _{T(AV)}	T _{hs}	55	°C			
1		1290	A			
I _T (RMS)	T _{hs}	25	°C			
1	50 Hz	8000	^			
ITSM	60 Hz	8380	A			
I ² t	50 Hz	320	kA ² s			
1 - 1	60 Hz	292	KA-S			
V _{DRM} /V _{RRM}		400 to 2000	V			
t _q	Typical	100	μs			
TJ		-40 to 125	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I_{DRM}/I_{RRM} MAXIMUM AT $T_J = T_J$ MAXIMUM mA				
	04	400	500					
VS-ST300CC	08	800	900					
	12	1200	1300	50				
	16	1600	1700	30				
	18	1800	1900					
	20	2000	2100					



PARAMETER	SYMBOL		VALUES	UNITS		
Maximum average on-state current		180° condu	180° conduction, half sine wave			Α
at heatsink temperature	$I_{T(AV)}$	double side	double side (single side) cooled			°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink tempe	erature double side cooled	1290	
		t = 10 ms	No voltage		8000	
Maximum peak, one-cycle	ı	t = 8.3 ms	reapplied	Sinusoidal half wave, initial $T_J = T_J$ maximum	8380	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		6730	
		t = 8.3 ms	reapplied		7040	
Maximum I ² t for fusing	l ² t	t = 10 ms	No voltage reapplied		320	
		t = 8.3 ms			292	
		t = 10 ms			226	
		t = 8.3 ms	reapplied		207	
Maximum I²√t for fusing	I ² √t	t = 0.1 to 10 ms, no voltage reapplied			3200	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum			V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			V
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ maximum			0.74	
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			0.73	mΩ
Maximum on-state voltage	V_{TM}	$I_{pk} = 1635 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$			2.18	V
Maximum holding current	I _H	T 05 °C				m 1
Typical latching current	ΙL	T _J = 25 °C, anode supply 12 V resistive load			1000	mA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dI/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/μs
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1$ A/ μ s $V_d = 0.67$ % V_{DRM} , $T_J = 25$ °C	1.0	
Typical turn-off time	tq	$\begin{array}{c} I_{TM}=300~A,~T_J=T_J~maximum,~dl/dt=40~A/\mu s,\\ V_R=50~V,~dV/dt=20~V/\mu s,~gate~0~V~100~\Omega,~t_p=500~\mu s \end{array}$	100	μs

BLOCKING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs		
Maximum peak reverse and off-state leakage current	I _{RRM,} I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	50	mA		



TRIGGERING						
PARAMETER	SYMBOL	TEGT COMPLETIONS		VALUES		UNITS
PARAMETER	STIMBUL	15	ST CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	P_{GM}	$T_J = T_J$ maximum,	t _p ≤ 5 ms	10.0		w
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	VV
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	t _p ≤ 5 ms	3	.0	Α
Maximum peak positive gate voltage	+ V _{GM}	T - T movimum	+ < 5 mg	20		V
Maximum peak negative gate voltage	- V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms			.0] '
	I _{GT}	T _J = - 40 °C	Maximum required gate trigger/	200	-	
DC gate current required to trigger		T _J = 25 °C		100	200	mA
		T _J = 125 °C	current/voltage are the lowest	50	-	
		T _J = - 40 °C	value which will trigger all units	2.5	-	
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C	12 V anode to cathode applied	1.8	3.0	V
		T _J = 125 °C		1.1	-	
DC gate current not to trigger	I _{GD}	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied		10	0.0	mA
DC gate voltage not to trigger	V_{GD}			0.	25	V

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum operating junction temperature range	T_{J}		- 40 to 125	- °C		
Maximum storage temperature range	T _{Stg}		- 40 to 150			
Maximum thermal registeres, junction to heateigh	D	DC operation single side cooled	0.09			
Maximum thermal resistance, junction to heatsink	R _{thJ-hs}	DC operation double side cooled	0.04	K/W		
Mariana tha mada a sistema a sa da basasial.	R _{thC-hs}	DC operation single side cooled	0.02	T\/ VV		
Maximum thermal resistance, case to heatsink		DC operation double side cooled	0.01			
Mounting force, ± 10 %			9800 (1000)	N (kg)		
Approximate weight			83	g		
Case style		See dimensions - link at the end of datasheet	E-PUK (TO-	200AB)		

△R _{thJ-hs} CONDUCTION								
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		RECTANGULAR CONDUCTION		TEST CONDITIONS	UNITS		
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS		
180°	0.010	0.011	0.007	0.007	$T_{J} = T_{J}$ maximum	K/W		
120°	0.012	0.012	0.012	0.013				
90°	0.015	0.015	0.016	0.017				
60°	0.022	0.022	0.023	0.023				
30°	0.036	0.036	0.036	0.037				

Note

• The table above shows the increment of thermal resistance Rthu-hs when devices operate at different conduction angles than DC

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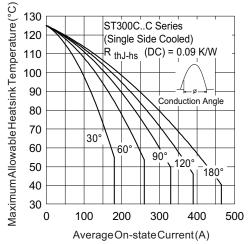


Fig. 1 - Current Ratings Characteristics

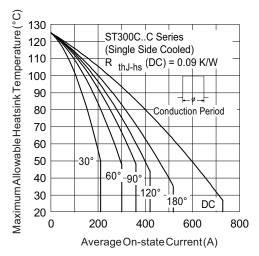


Fig. 2 - Current Ratings Characteristics

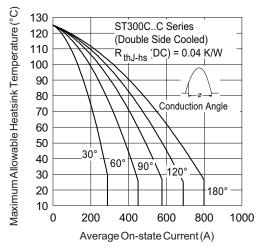


Fig. 3 - Current Ratings Characteristics

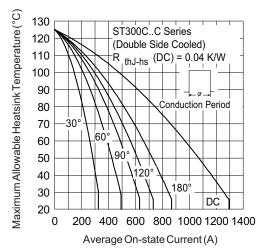


Fig. 4 - Current Ratings Characteristics

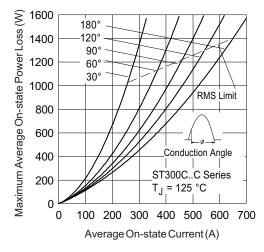


Fig. 5 - On-State Power Loss Characteristics

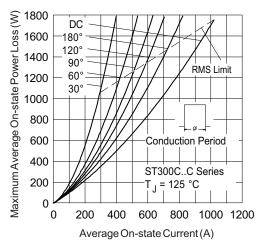


Fig. 6 - On-State Power Loss Characteristics

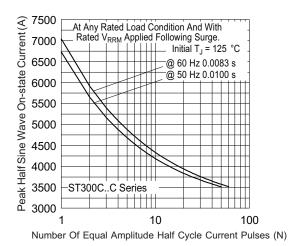


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

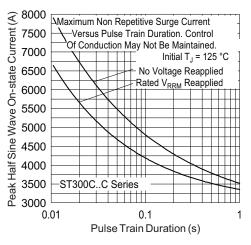


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

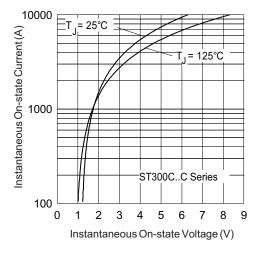


Fig. 9 - On-State Voltage Drop Characteristcs

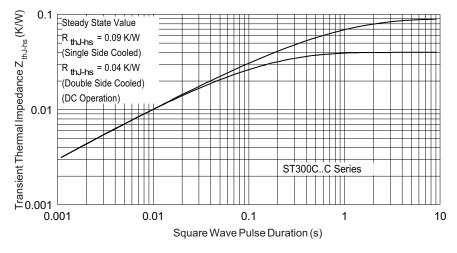


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

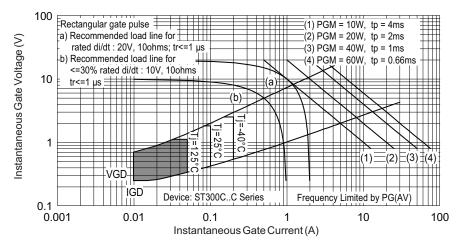
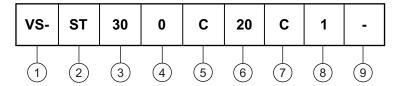


Fig. 11 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Thyristor

3 - Essential part number

4 - 0 = converter grade

5 - C = ceramic PUK

- Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

7 - C = PUK case E-PUK (TO-200AB)

8 - 0 = eyelet terminals (gate and auxiliary cathode unsoldered leads)

1 = fast-on terminals (gate and auxiliary cathode unsoldered leads)

2 = eyelet terminals (gate and auxiliary cathode soldered leads)

3 = fast-on terminals (gate and auxiliary cathode soldered leads)

9 - Critical dV/dt: • None = 500 V/µs (standard value)

• L = 1000 V/µs (special selection)

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95075			

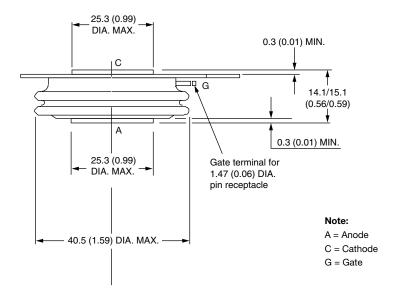


E-PUK (TO-200AB)

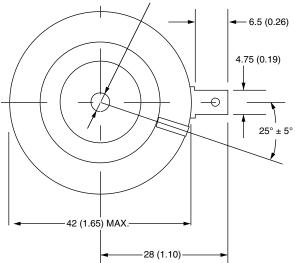
DIMENSIONS in millimeters (inches)

Anode to gate

Creepage distance: 11.18 (0.44) minimum Strike distance: 7.62 (0.30) minimum



2 holes 3.56 (0.14) x 1.83 (0.07) minimum deep



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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